SHARP

ZENIGATA LED

Sep 1, 2016

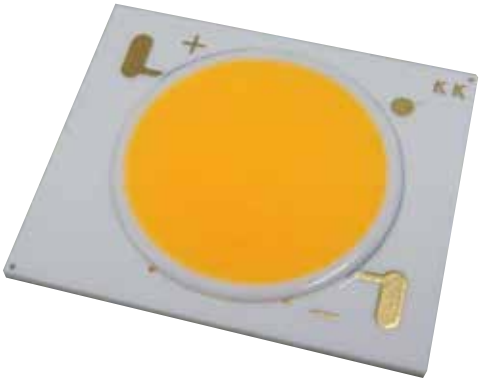
SPECIFICATIONS

MEGA ZENIGATA-LED

GW6D*E**BF6

*E**:ME27,ME30,ME35,ME40

GE27,GE30,GE35,GE40



ZENIGATA

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LIGHTING BUSINESS UNIT
ELECTRONIC COMPONENTS AND DEVICES BU
SHARP CORPORATION

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(2) intentional act, negligence or wrong/poor handling.
(3) equipment which Sharp products are connected to or mounted in.
(4) disassembling, reforming or changing Sharp products.
(5) installation problem.
(6) act of God or other disaster (natural disaster, fire, flood, etc.)
(7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)
(8) special environment (factory, coastal areas, hotspring area, etc.)
(9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment.
(10) the factors not included in the product specification sheet.
4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

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GW6D*E**BF6 specifications

1. Application

These specifications apply to the light emitting diode module Model No. GW6D*E**BF6.

[LED module (InGaN Blue LED chip + Phosphor)]

Main application : Lighting

2. External dimensions and equivalent circuit ——— Refer to Page 2.

3. Ratings and characteristics ——— Refer to Page 3 ～ 7.

3-1. Absolute maximum ratings

3-2. Electro-optical characteristics

3-3. Derating curve

3-4. Characteristics diagram (TYP.)

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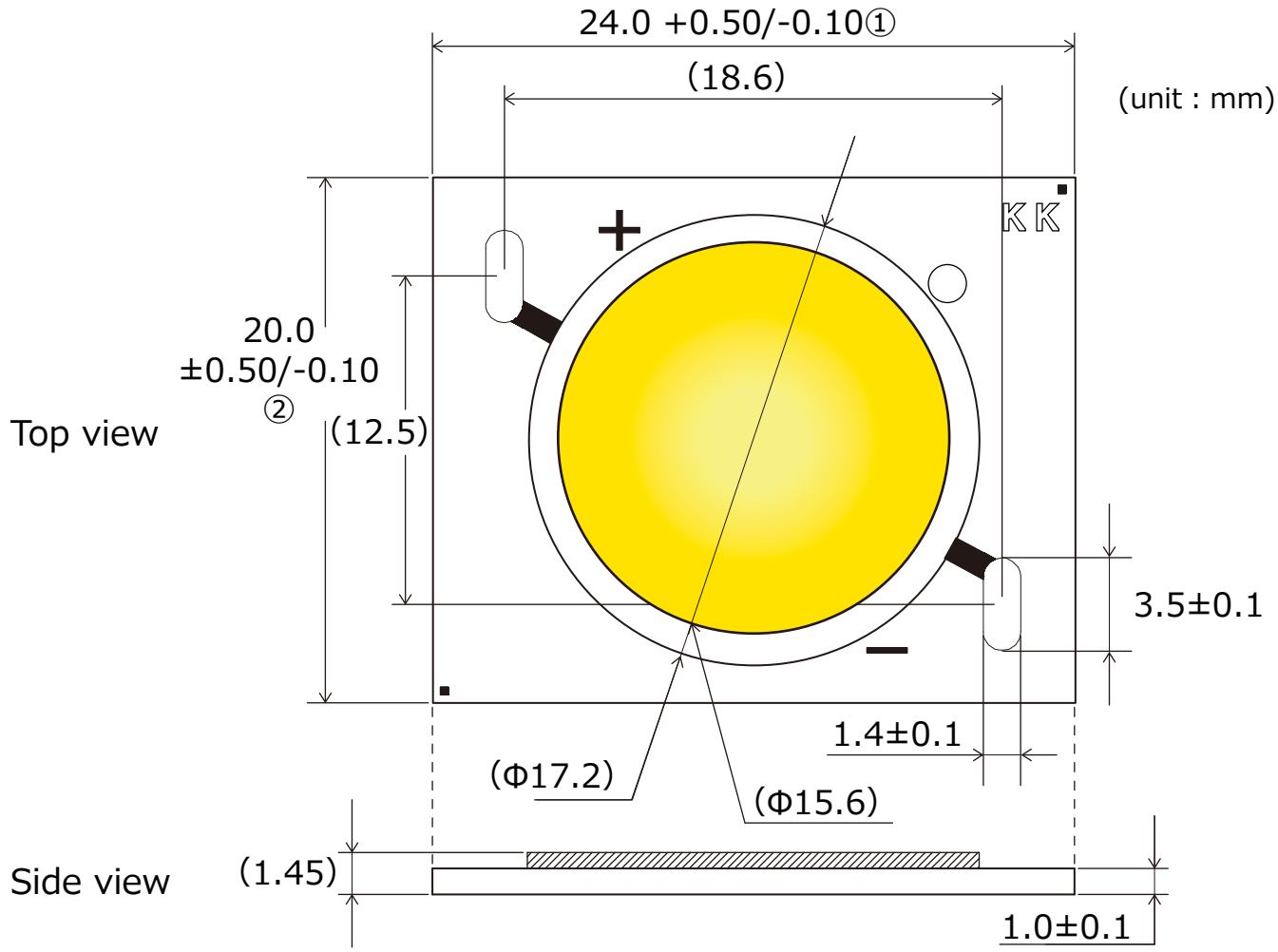
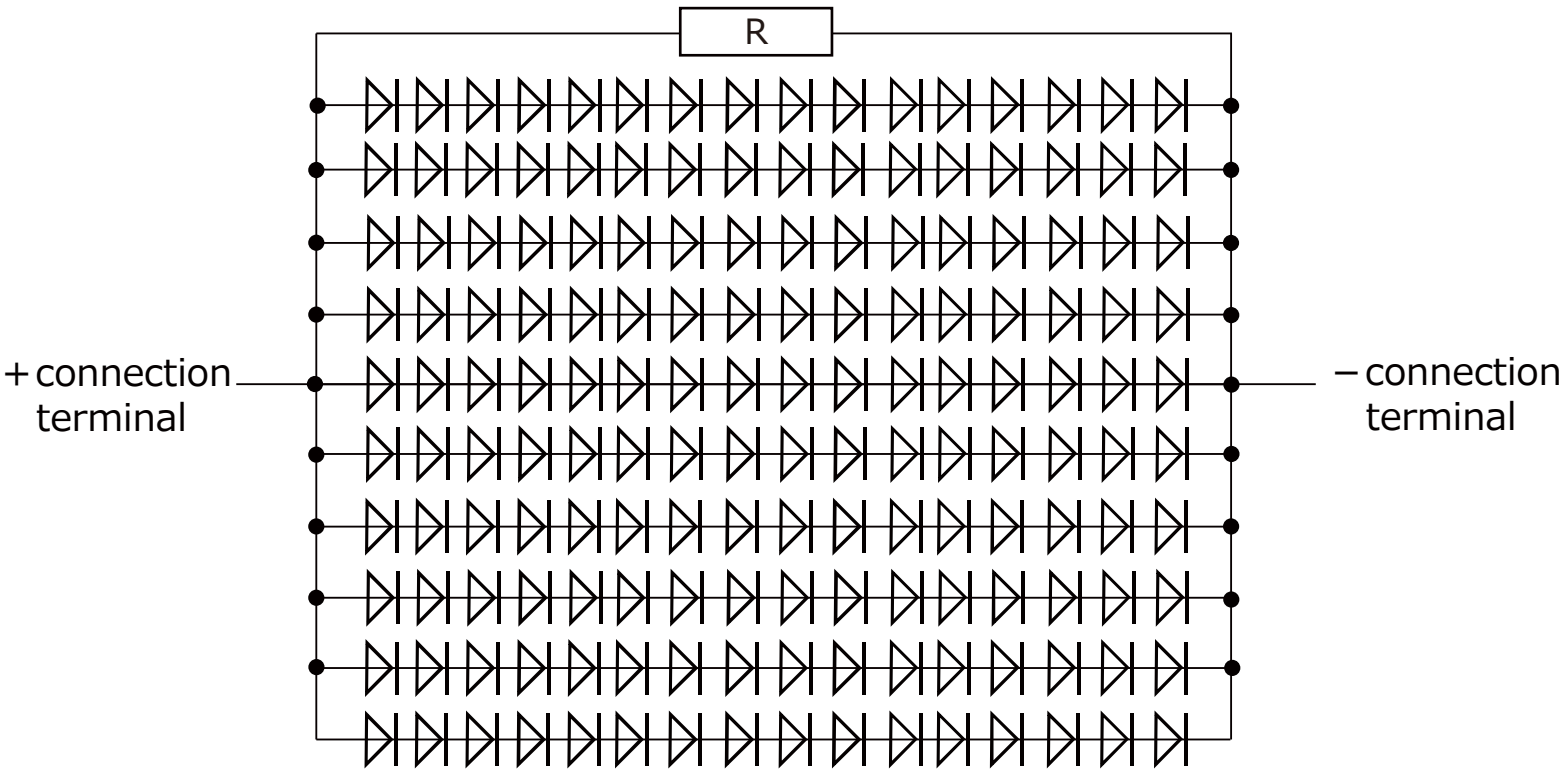
2. External dimensions and equivalent circuit





16 series × 10 parallel = 160 pcs of LEDs

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3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power Dissipation ※1,4	P	60.8	W
Forward Current ※1,4	I_F	1 200	mA
Reverse Voltage ※2,4	V_R	-15	V
Operating Temperature ※3	T_{opr}	-30 ～ +100	℃
Storage Temperature	T_{stg}	-40 ～ +100	℃
Junction Temperature	T_j	145	℃

（※１）Power dissipation and forward current are the values when the module temperature is set lower than the rating by using an adequate heat sink.

（※２）The maximum rating of reverse voltage is assumed, after considering the voltage that occur due to initial connection error that may occur suddenly.
(Not dealing with the possibility of always-on reverse voltage.)

（※３）Operating temperature is the Case temperature Tc
(Refer to measuring point for case temperature in the next page.)
Refer to "Derating curve" in the next page as for operating current.

（※４）Tc=25℃

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3-2.Electro-optical characteristics

Above lumen values are center number of minimum and maximum values of each color temperature.
Actual performance is known by rank information of each delivery.

(Tj=90℃)

ME**	Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
common	Forward Voltage※5	V_F	I_F=950mA	41.5	(46.1)	50.7	V
27	Luminous Flux※6	Φ	I_F=950mA	4 350	-	(5 950)	lm
	Chromaticity Coordinates※7	x		-	(0.4610)	-	-
		y		-	(0.4150)	-	-
	Color Temperature	-		-	(2 720)	-	K
	General Color Rendering Index※8	Ra		80	(82)	-	-
30	Luminous Flux※6	Φ	I_F=950mA	4 750	-	(6 350)	lm
	Chromaticity Coordinates※7	x		-	(0.4370)	-	-
		y		-	(0.4030)	-	-
	Color Temperature	-		-	(3 000)	-	K
	General Color Rendering Index※8	Ra		80	(82)	-	-
35	Luminous Flux※6	Φ	I_F=950mA	4 750	-	(6 750)	lm
	Chromaticity Coordinates※7	x		-	(0.4090)	-	-
		y		-	(0.3930)	-	-
	Color Temperature	-		-	(3 440)	-	K
	General Color Rendering Index※8	Ra		80	(82)	-	-
40	Luminous Flux※6	Φ	I_F=950mA	5 150	-	(6 750)	lm
	Chromaticity Coordinates※7	x		-	(0.3820)	-	-
		y		-	(0.3800)	-	-
	Color Temperature	-		-	(3 980)	-	K
	General Color Rendering Index※8	Ra		80	(82)	-	-

(Note) Values inside parentheses are shown for reference purpose only.

※5 (After 5 ms drive, Measurement tolerance: ± 3 %)

※6 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A
(After 5 ms drive, Measurement tolerance: ± 7 %)

※7 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A
(After 5 ms drive, Measurement tolerance: ± 0.005)

※8 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A
(After 5 ms drive, Measurement tolerance: ± 2)

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Above lumen values are center number of minimum and maximum values of each color temperature.
Actual performance is known by rank information of each delivery.

(Tj=90℃)

GE**	Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
common	Forward Voltage※5	V_F	I_F=950mA	41.5	(46.1)	50.7	V
27	Luminous Flux※6	Φ	I_F=950mA	3 550	-	(5 150)	lm
	Chromaticity Coordinates※7	x		-	(0.4610)	-	-
		y		-	(0.4150)	-	-
	Color Temperature	-		-	(2 720)	-	K
	General Color Rendering Index※8	Ra		90	(93)	-	-
30	Luminous Flux※6	Φ	I_F=950mA	3 550	-	(5 150)	lm
	Chromaticity Coordinates※7	x		-	(0.4370)	-	-
		y		-	(0.4030)	-	-
	Color Temperature	-		-	(3 000)	-	K
	General Color Rendering Index※8	Ra		90	(93)	-	-
35	Luminous Flux※6	Φ	I_F=950mA	3 950	-	(5 550)	lm
	Chromaticity Coordinates※7	x		-	(0.4090)	-	-
		y		-	(0.3930)	-	-
	Color Temperature	-		-	(3 440)	-	K
	General Color Rendering Index※8	Ra		90	(93)	-	-
40	Luminous Flux※6	Φ	I_F=950mA	3 950	-	(5 950)	lm
	Chromaticity Coordinates※7	x		-	(0.3820)	-	-
		y		-	(0.3800)	-	-
	Color Temperature	-		-	(3 980)	-	K
	General Color Rendering Index※8	Ra		90	(93)	-	-

(Note) Values inside parentheses are shown for reference purpose only.

※5 (After 5 ms drive, Measurement tolerance: ± 3 %)

※6 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A
(After 5 ms drive, Measurement tolerance: ± 7 %)

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※8 Monitored by Sharp's 1m integrating sphere and Otsuka electronics SR-2000A
(After 5 ms drive, Measurement tolerance: ± 2)

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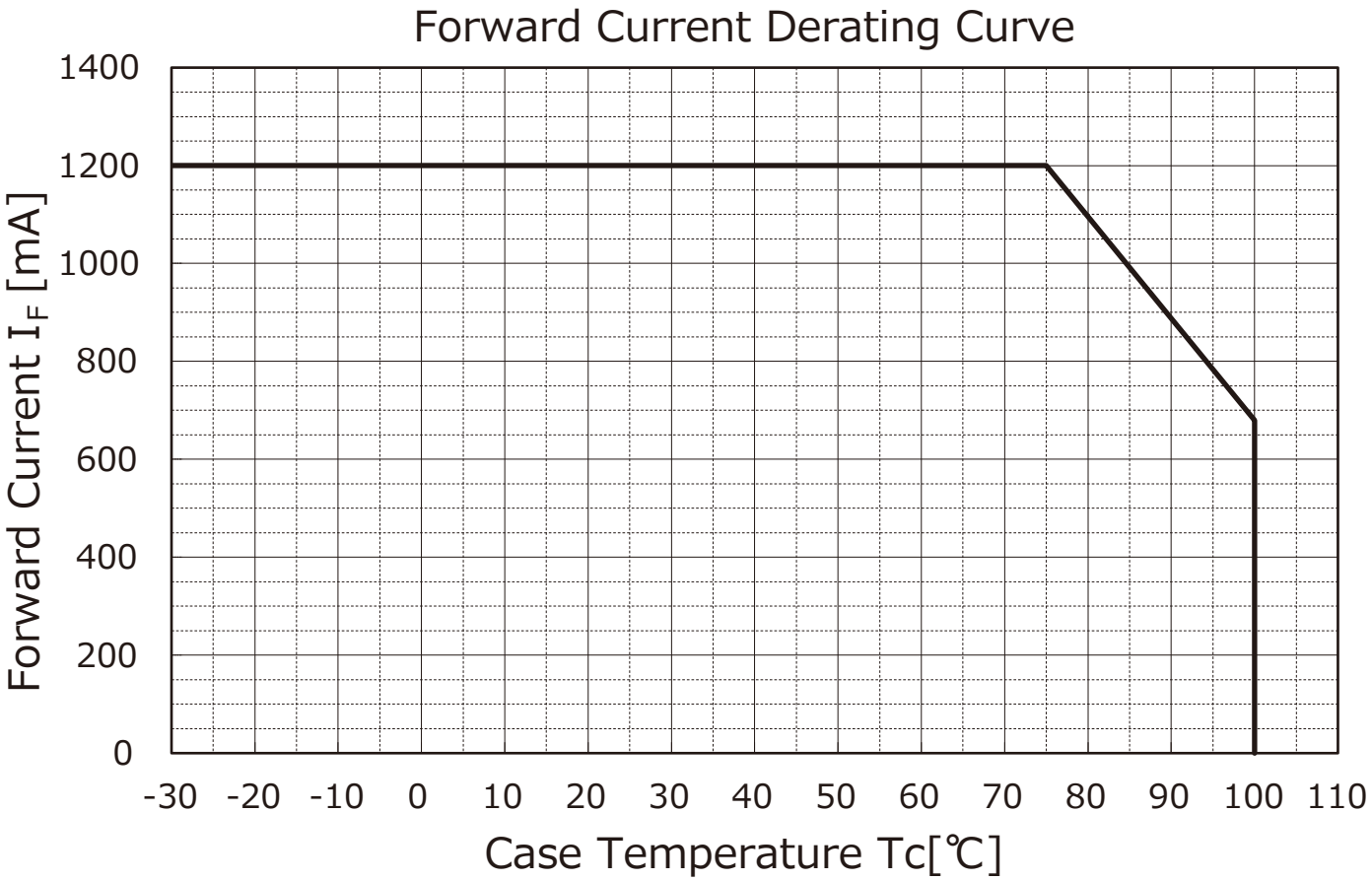
3-3.Derating curve



(Note) To keep the case temperature lower than the rating, enough heat-radiation performance needs to be secured by using an adequate heat sink (refer to section 7-③).

For soldering connection, please evaluate in your usage environment to make sure soldering reliability.

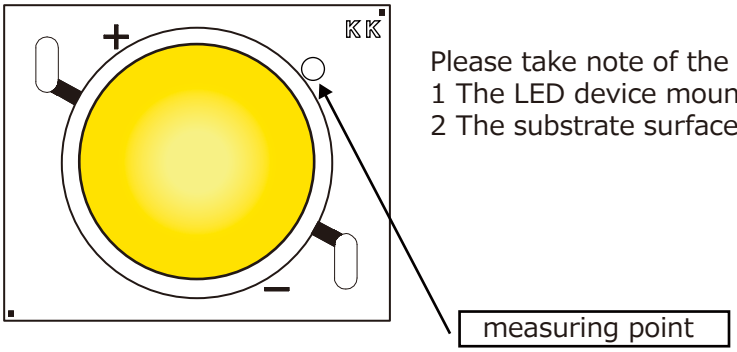
(Above derating curve is specified to LED device, not for soldering connection)

And please consider to avoid physical stress between wire and substrate,

and some protection like silicon bond on top of soldered wire is recommended.

Please ensure the maintenance of heat radiation does not exceed case temperature over the rating in operation.

(Measuring point for case temperature)



Please take note of the following, when measuring case temperature.
1 The LED device mounting surface should be flat/plain surface.
2 The substrate surface temperature should be uniform.

Thermal Resistance: 1.0 ℃/W(Typical value)

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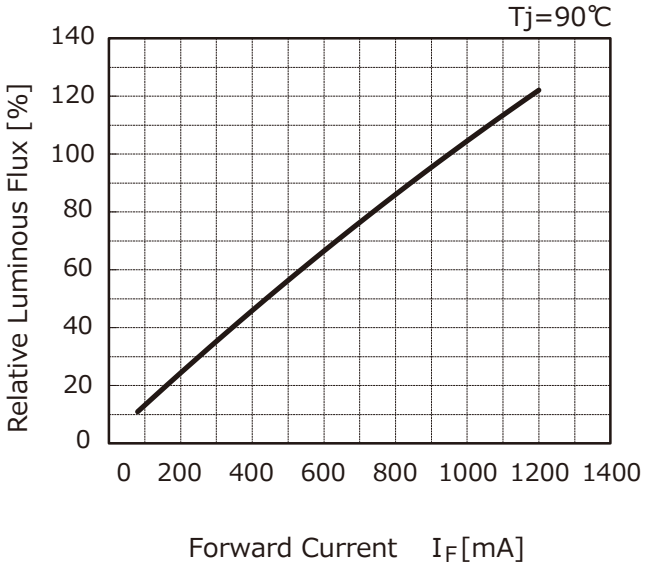
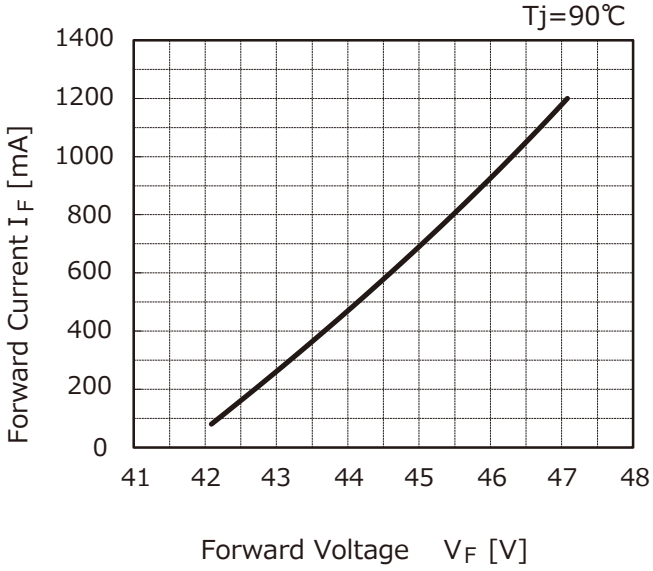
3-4.Characteristics diagram (TYP.)

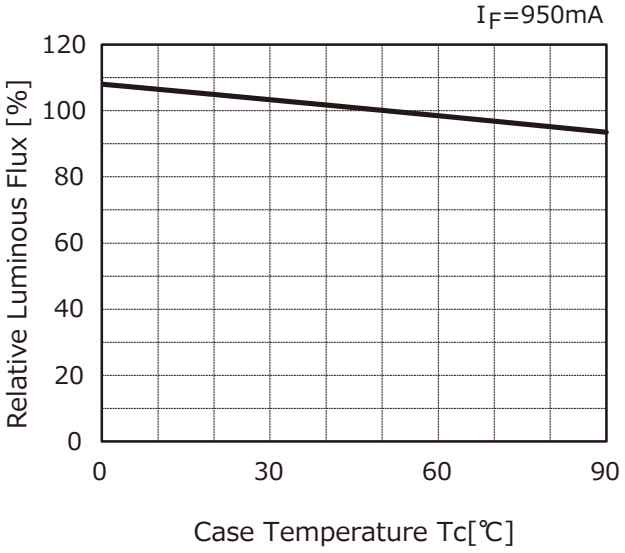
Forward Current vs. Relative Luminous Flux



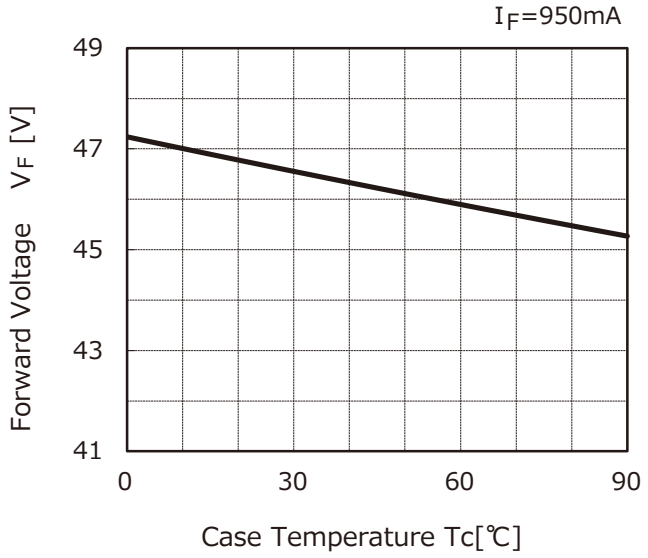
Forward Voltage vs. Forward Current



Case Temperature vs. Relative Luminous Flux



Case Temperature vs. Forward Voltage



(Note) Characteristics data shown here are for reference purpose only. (Not guaranteed data)

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4. Reliability

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

No.	Test item	Test conditions	Samples n	Defective C	LTPD (%)
1	Temperature Cycle	- 40 ℃(30 min) ～ + 100 ℃(30 min), 100 cycles	11	0	20
2	Temperature Humidity Storage	Tstg = + 60 ℃, RH = 90 %, Time = 1000 h	11	0	20
3	High Temperature Storage	Tstg = + 100℃, Time = 1000 h	11	0	20
4	Low Temperature Storage	Tstg = - 40 ℃, Time = 1000 h	11	0	20
5	Steady State Operating Life	Tc = 90 ℃, I_F= 950 mA, Time = 1000 h	11	0	20
6	Shock	Acceleration: 15000 m/s^2, Pulse width: 0.5 ms Direction: 3 directions (X, Y and Z) 3 trials in each direction	5	0	50
7	Vibration	Frequency: 100 to 2000 Hz for 4 minutes per trial Acceleration: 200 m/s^2 Direction: 3 directions (X, Y and Z) 4 trials in each direction	5	0	50

4-2.Failure criteria

No.	Parameter	Symbol	Failure criteria
1	Forward Voltage	V_F	V_F > Initial value ×1.1
2	Luminous Flux	Φ	Φ < Initial value ×0.7

5. Quality level

5-1.Applied standard(ISO2859-1)

5-2.Sampling inspection A single normal sampling plan, level S-4.

5-3.Inspection items and defect criteria

No.	Item	Defect criteria	Classification	AQL
1	No radiation	No light emitting	Major defect	0.1
2	Electro-optical characteristics	Not conforming to the specification		
3	External dimensions	Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity values)		
4	Appearance	Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by. <If any question arises regardless of above mentioned criterion> ■Foreign material, scratch, or bubble at emitting area: 0.8 mm φ ■Fiber generation at emitting area: 0.2 mm in width and 2.5 mm in length ■Foreign material at connection terminal: 0.8 mm φ ■Substrate burr on edge: Over dimension tolerance	Major defect	0.4

(Note) Products with removable foreign material attached on are not determined to be defective.

(Note) Substrate cracks that do not effect the electrical/optical charecteristics are not determined to be defective.

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6. Supplements

6-1.Chromaticity rank table (Tolerance : x,y±0.005)

2 700K (I_F =950mA,Tj=90℃)

Rank		Chromaticity coordinates			
		Point 1	Point 2	Point 3	Point 4
1	x	0.4600	0.4555	0.4620	0.4665
	y	0.4200	0.4100	0.4100	0.4200

3 000K (I_F =950mA,Tj=90℃)

Rank		Chromaticity coordinates			
		Point 1	Point 2	Point 3	Point 4
1	x	0.4360	0.4315	0.4380	0.4425
	y	0.4080	0.3980	0.3980	0.4080

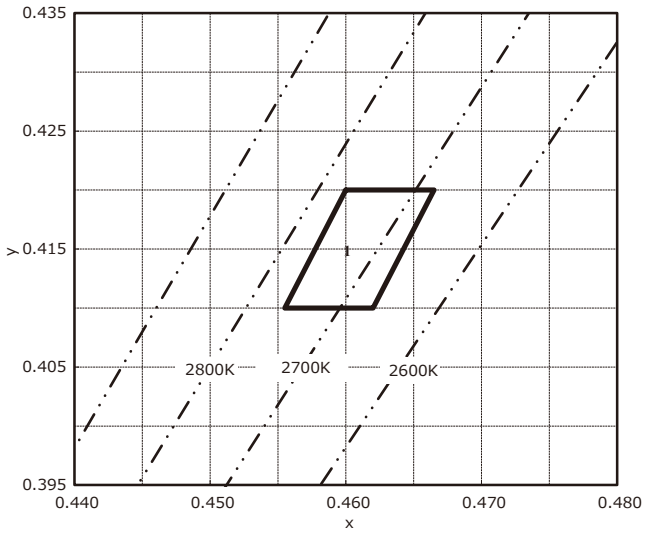
3 500K (I_F =950mA,Tj=90℃)

Rank		Chromaticity coordinates			
		Point 1	Point 2	Point 3	Point 4
1	x	0.4080	0.4035	0.4100	0.4145
	y	0.3980	0.3880	0.3880	0.3980

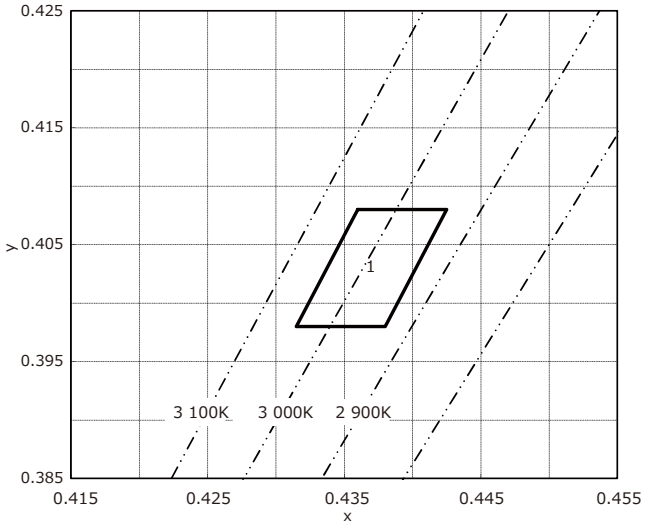
4 000K (I_F =950mA,Tj=90℃)

Rank		Chromaticity coordinates			
		Point 1	Point 2	Point 3	Point 4
1	x	0.3810	0.3765	0.3830	0.3875
	y	0.3850	0.3750	0.3750	0.3850

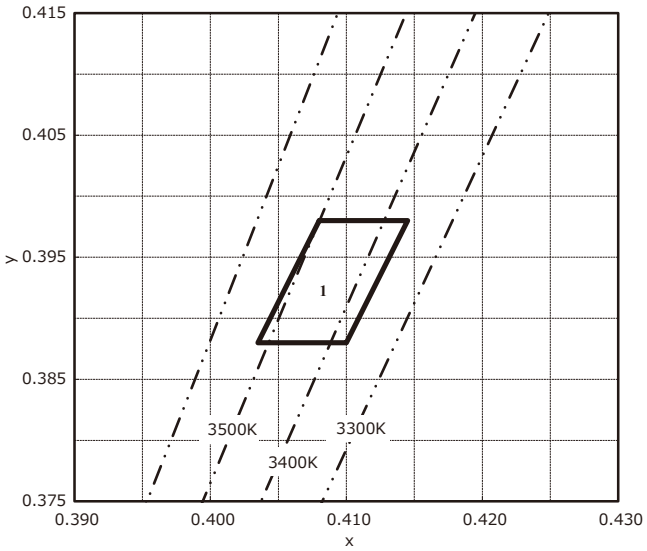
2 700K Chromaticity Diagram



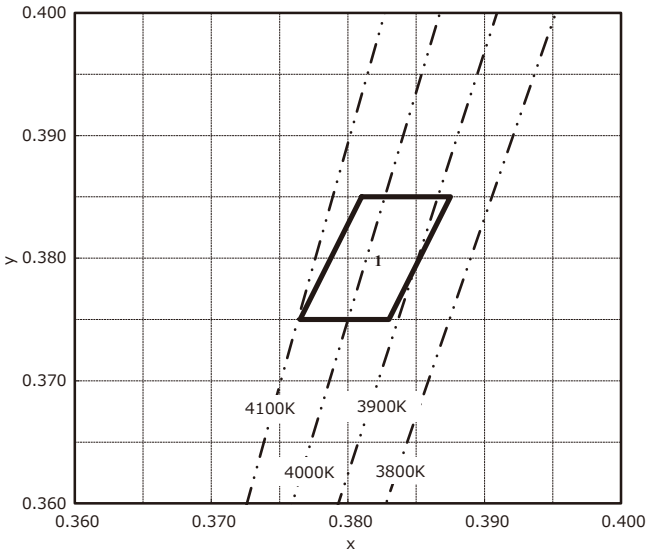
3 000K Chromaticity Diagram



3 500K Chromaticity Diagram



4 000K Chromaticity Diagram



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6-2. lumen binning

Luminous Flux rank table

Rank	min	max	unit	condition
A	3 550	3 950	lm	I_F=950mA
B	3 950	4 350		
C	4 350	4 750		
D	4 750	5 150		
E	5 150	5 550		
F	5 550	5 950		
G	5 950	6 350		
H	6 350	6 750		
I	6 750	7 150		

Luminous Flux rank by Color Temperature
(GW6DMD**BF6 model)

Rank	Color Temperature（K）			
	2 700	3 000	3 500	4 000
A				
B				
C				
D				
E				
F				
G				
H				
I				

(GW6DGD**BF6 model)

Rank	Color Temperature（K）			
	2 700	3 000	3 500	4 000
A				
B				
C				
D				
E				
F				
G				
H				
I				

※These values are for reference purpose only.
Units from the above ranks will be shipped.
Luminous Flux rank may change to higher one in future.
The rank combination rattio per shipment will be decided by SHARP.

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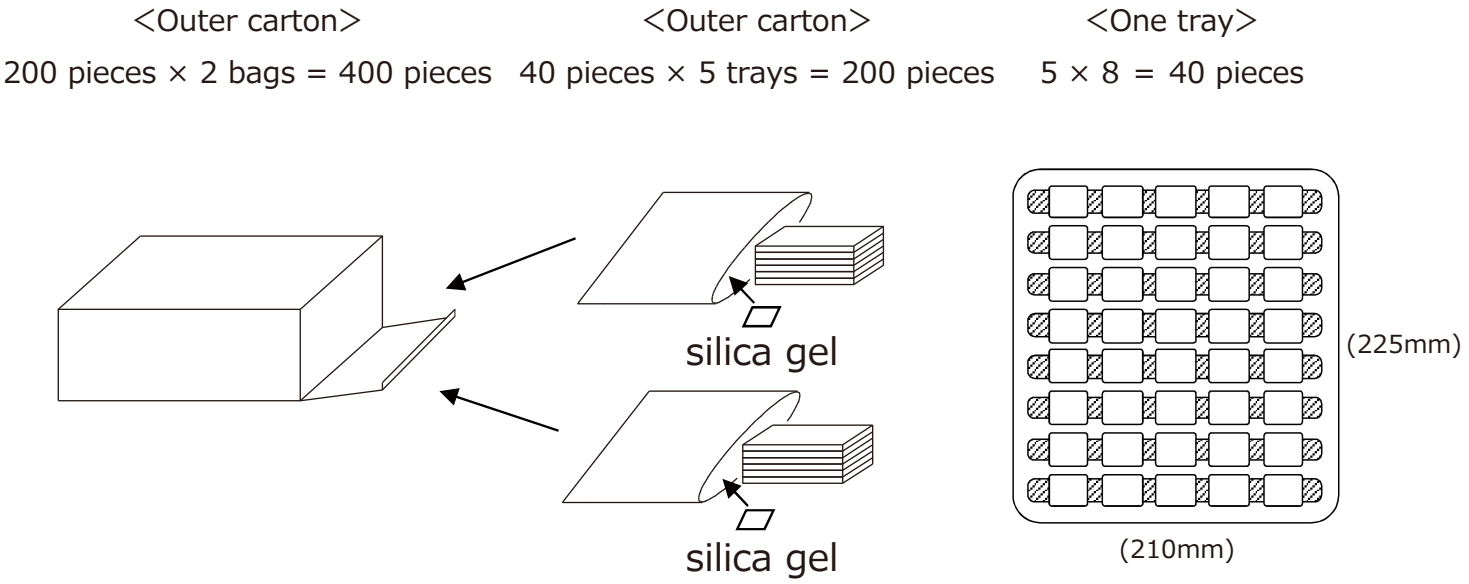
6-3.Packing

- ■ One tray composed of 40 pieces
- ■ 5 trays (200 piecies) and one upper lid-tray in one moisture-proof bag
- ■ 2 bags (400 pieces) in one carton
- ■ Dimensions of outer carton: 235 × 220 × 90 mm (Reference value)

(Note 1) There are cases of one carton composed of one bag. (200 pieces)

(Note 2) State of packing is subject to change.



6-3.Label

1) Outer carton
Following label is attached on outer carton.
(Note 3) Label format is subjected to change.

SHIPMENT TABLE
PART No. GW6D*E**BF6 ← Model number
(GW6D*E**BF6M) ← (Model number + suffix code)
QUANTITY : 400 ← Quantity
LOT No. XX11B25 ← Lot No.
RANK 1 ← Rank
SHARP CORPORATION RC ← Production country
MADE IN ********** ・MADE IN ****
・MADE IN ****
SHARP LABEL

・Lot No. indication

XX	11	B	25
①	②	③	④

① Production plant code A
② Shipping year（Year last 2 digits）
③ Shipping month
(from January to December in ABC order)
④ Shipping date（01 ～ 31）
*Notation may be different

2) Moisture-Proof bag
Following label is attached on moisture-proof bags.
(Note 3) Label format is subjected to change.

SHIPMENT TABLE
PART No. GW6D*E**BF6 ← Model number
(GW6D*E**BF6M) ←(Model number+ suffix code)
QUANTITY : 200 RANK 1 ← Quantity and Rank
LOT No. 5020G2064A ← Lot No.
SHARP CORPORATION RC ← Production country
MADE IN ********** ・MADE IN ****
・MADE IN ****
SHARP LABEL

・Lot No. indication

XX	1	9	G	11	123	A
①	②	③	④	⑤	⑥	⑦

① Production plant code B
② Shipping year（Year last digit）
③ Shipping month（1 ～ 9 or O, N, D）
④ Fixed code G
⑤ Shipping date（01 ～ 31）
⑥ Serial No.
⑦ Backup code A
※Notation may be different

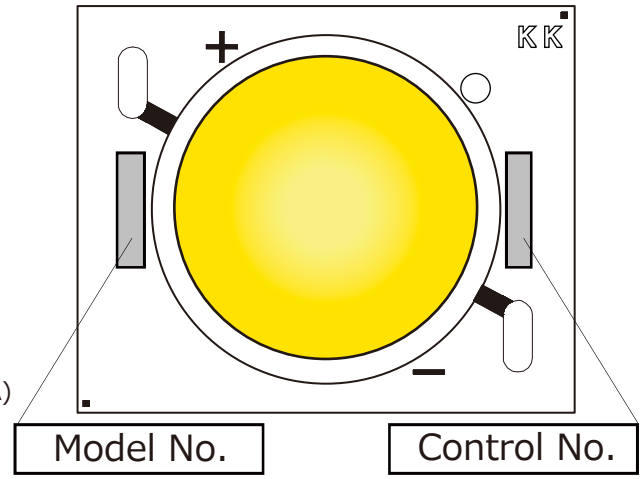
Indication printed on product
Model No. and control No. are indicated on substrate surface.

1）Model No.
Abbreviated Model No ' *E**BF6 ' is indicated.

2）Control No.
Indicated as follows;

XX	12	B	11	- 1
①	②	③	④	⑤

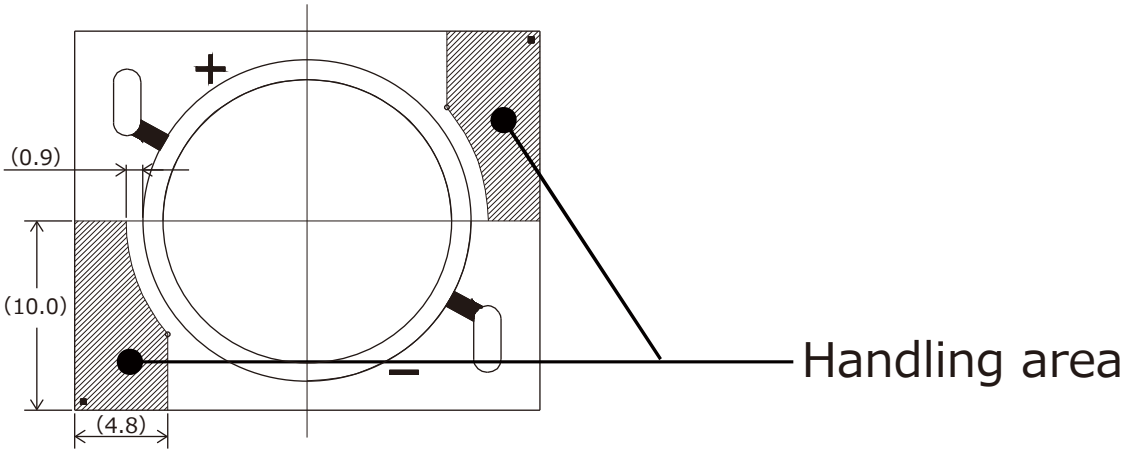
① Production plant code (to be indicated alphabetically)
② Year of production (the last two figures of the year)
③ Month of production
(to be indicated alphabetically with January corresponding to A)
④ Date of production (01 ～ 31)
⑤ Rank (Luminous Flux:)



7. Precautions

①Storage conditions
Please follow the conditions below.
・Before opened: Temperature 5 ～ 30 ℃, Relative humidity less than 60 %.
(Before opened LED should be used within a year)
・After opened: Temperature 5 ～ 30 ℃, Relative humidity less than 60 %.
(Please apply soldering within 1 week)
・After opened LED should be kept in an aluminum moisture proof bag with a moisture absorbent material (silica gel).
・Avoid exposing to air with corrosive gas.
If exposed, electrode surface would be damaged, which may affect soldering.
Furthermore, if the device is stored in an environment which contain elements that could volatize resin material,
then the volatized resin particles may stick to electrodes, which may result in connection failures.
②Usage conditions
This product is not designed for the use under any of the following conditions.
Please carefully check the performance and reliability well enough in case of using under any of the following conditions;
・In a place with a lot of moisture, dew condensation, briny air, and corrosive gas.
(Cl, H2S, NH3, SO2, NOX, etc.)
・Under the direct sunlight, outdoor exposure, and in a dusty place.
・In water, oil, medical fluid, and organic solvent.
Please do not use component parts like rubber which may contain sulfur (gasket packing, adhesive material,etc.).
Please note that any strong acidic or alcoholic elements could effect the silicon resin used in the LED device.
The heat and light released from the LED device, could generate halogen gas from the surrounding materials, which may have adverse impact on the module. Before using please consider carefully about this issue.
③Heat radiation and Installation
If forward current (IF) is applied to single-state module at any current, there is a risk of damaging LED or emitting smoke, due to increase in temperature.
Equip with specified heat radiator(heat sink), and avoid heat being stuffed inside the module.
Material of substrate is alumina ceramic. If installed inappropriately, trouble of insufficient heat radiation may occur , which may result in board cracks or lighting defects due to overheat. Please take particular notice for installation.
Refer to the following cautions while installing the LED device on heat sink.
・Apply thermolysis adhesive, adhesive sheet or peculiar connector when mounted on heat radiator.
In case of applying adhesive or adhesive sheet only, check the effectiveness and reliability before fixing.
If LED comes off from heat radiator, unusual temperature rise entails hazardous phenomena including device deterioration, coming off of solder at leads, and emitting smoke, along with LED device deffects.
・When LED device is mechanically fixed or locked, Please take into consideration regarding the method of attachment due to fail from stress.
・Please apply appropriate stress and design carefully, when fixing the LED device using holder. Any excessive or uneven stress could break LED device' s substrate.
・Avoid convexly uneven boards.
Convex board is subject to substrate cracking or debasement of heat release.

・It is recommended to apply adhesive or adhesive sheet with high thermal conductivity for radiation of heat effectively.
・Please take care about the influence of color change of adhesive or adhesive sheet in initial and long term period, which may affect light output or color due to change of reflectance from backside.
・Any excessive or uneven stress on the ceramic substrate could break the substrate. Please design such that, proper/uniform stress is applied on the substrate, when fixing the LED device using a holder.
・When fixing the LED device with a holder, please take note if any excessive or uneven stress is applied when pressing the substrate with holder. Due to this, the gap may arise between LED device and adhesive material, which may affect the heat dissipation of the device.
・Do not touch resin part including white resin part on the surface of LED.
No light emission may occur due to damage of resin or cutting wire of LEDs by outer force.
When using tweezers, please handle by ceramic substrate part and avoid touching resin part.
For mounting, please handle by side part of ceramic or the specified area shown below.



・The outer edges of the substrate may be uneven in some cases. Please avoid choosing these areas as fixing points, while designing for installation.
・In case of using heat radiation sheet or heat radiation adhesive, light reflection or absorption of these materials may influence the output of LED device. Especially, the color change that occur due to l ong-term use has direct impact on output of LED devices, and hence careful consideration is required while choosing the radiation sheet ro adhesive.
・Please avoid using any materials(such as PBT resin) that may release corrosive gases, around LED device.

④

Connecting method

In case soldering is used for conncetions, follow the conditions mentioned below, to preserve the connection strength.

・Use soldering iron with thermo controller (tip temperature 380 ℃), within 5 seconds per one place.

・Secure the solderwettability on whole solder pad and leads.

・During the soldering process, put the ceramic board on materials whose conductivity is poor enough not to radiate heat of soldering.

・Warm up (with using a heated plate) the substrate is recommended before soldering.
(preheat condition: 100 ℃ ～ 150 ℃, within 60 sec)

・Avoid touching any part of resin with soldering iron.

・This product is not designed for reflow and flow soldering.

・Avoid such lead arrangement as applying stress to solder-applied area.

・Please do not detach solder and make re-solder.

・Please solder evenly on each electrode.

・Please prevent flux from touching to resin.

・Do the soldering on stable stand. Avoid soldering on moving or vibrating objects.

・Please avoid touching the soldering unit to resin.

・In case of using at high temperatures, use the soldering material that can withstand creep failures.

・When using the device with solder-less connection, please carefully study the reliability of solder-less connection before use.

⑤

Static electricity

This product is subject to static electricity, so take measures like wearing wrist band to cope with it.
Install circuit protection device to drive circuit, if necessary.

⑥

Drive method

・Any reverse voltage cannot be applied to LEDs when they are in operation or not.
Design a circuit so that any flow of reverse or forward voltage can not be applied to LEDs when they are out of operation.

・Module is composed of LEDs connected in both series and parallel.
Constant voltage power supply runs off more than specified current amount due to lowered VF caused by temperature rise. Constant current power supply is recommended to drive.

・Be cautious while putting on/off the power supply, as excess current, excess voltage or reverse voltage may get injucted to the device in some cases.

⑦

Cleaning

Avoid cleaning, since LED device may be effected in some cases by cleaning.

⑧

Color-tone variation

Chromaticity of this product is monitored by integrating sphere right after the operation.
Chromaticity varies depending on measuring method, light spread condition, or ambient temperature.
Please verify your actual conditions before use.

⑨

Safety

·Looking directly at LEDs for a long time may result in hurting your eyes.
·In case that excess current (over ratings) is supplied to the device, hazardous phenomena including abnormal heat generation, emitting smoke, or catching fire can be caused.
Take appropriate measures to excess current and voltage.
・In case of solder connecting method, there is a possibility of fatigue failure by heat.
Please fix the leads in such case to protect from short circuit or leakage of electricity caused by contact.
・Please confirm the safety standards or regulations of application devices.
・Please be careful with substrate edges, that may injure your hands.

⑩

Other cautions

Guarantee covers the compliance to the quality standards mentioned in the specifications, however it does not cover the compatibility with application of the end-use, including assembly and usage environment.
In case any quality problems occurred in the application of end-use, details will be separately discussed and determined between the parties hereto.

SHARP

http://www.sharp-world.com/products/device/